



(12) **EUROPEAN PATENT APPLICATION**

(43) Date of publication:
04.06.2014 Bulletin 2014/23

(51) Int Cl.:
B41J 2/19 (2006.01)

(21) Application number: **13195104.8**

(22) Date of filing: **29.11.2013**

(84) Designated Contracting States:
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR
Designated Extension States:
BA ME

(72) Inventor: **Melde, Kai**
San Francisco, CA California 94117 (US)

(74) Representative: **Lord, Michael**
Gill Jennings & Every LLP
The Broadgate Tower
20 Primrose Street
London EC2A 2ES (GB)

(30) Priority: **29.11.2012 US 201213688769**

(71) Applicant: **Palo Alto Research Center Incorporated**
Palo Alto, California 94304 (US)

(54) **Bypass flow path for bubbles in an ink jet printer**

(57) An apparatus includes a bypass flow path between an ink supply port and a vent port and a primary flow path between the ink supply port and an ink delivery port. A first flow velocity of the bypass flow path is higher

than a second flow velocity of the primary flow path. The first flow velocity induces bubbles to travel via the bypass flow path instead of the primary flow path.

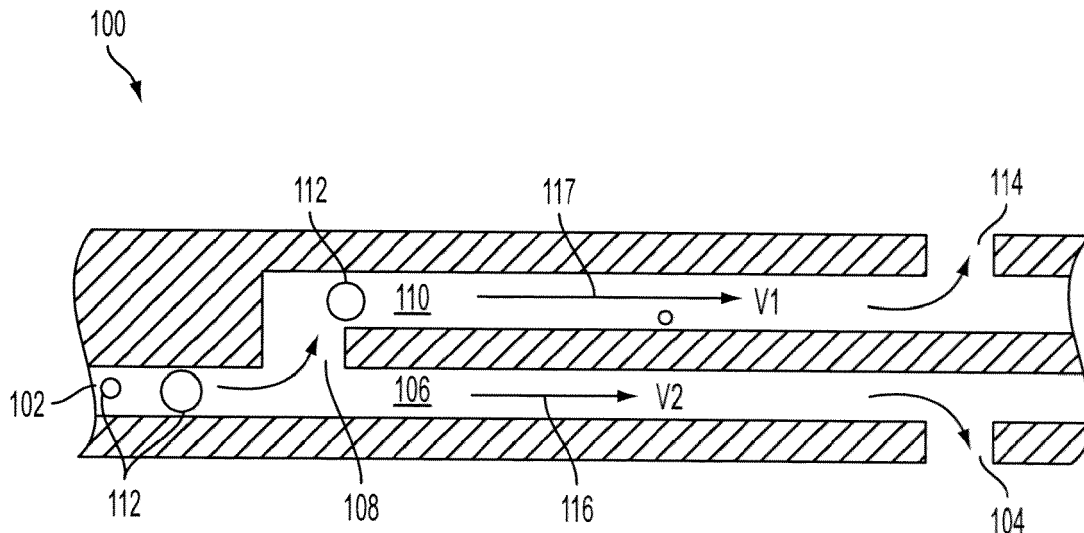


FIG. 1

Description

BACKGROUND

[0001] Ink jet printers operate by ejecting small droplets of liquid ink onto print media according to a predetermined pattern. In some implementations, the ink is ejected directly on a final print media, such as paper. In other implementations, the ink is ejected on an intermediate print media, e.g. a print drum, and is then transferred from the intermediate print media to the final print media. Some ink jet printers use cartridges of liquid ink to supply the ink jets. Some printers use phase-change ink which is solid at room temperature and is melted before being jetted onto the print media surface. Phase-change inks that are solid at room temperature allow the ink to be transported and loaded into the ink jet printer in solid form, without the packaging or cartridges typically used for liquid inks.

SUMMARY

[0002] Examples described herein are directed to an ink jet manifold. In one embodiment, an apparatus includes a bypass flow path between an ink supply port and a vent port and a primary flow path between the ink supply port and an ink delivery port. A first flow velocity of the bypass flow path is higher than a second flow velocity of the primary flow path. The first flow velocity induces bubbles to travel via the bypass flow path instead of the primary flow path. The apparatus may include a heater configured to induce a first temperature in the bypass flow path that is higher than a second temperature of the primary flow path. In such a case, the first temperature reduces a viscosity of ink flowing in the first path such that the first flow velocity of the bypass flow path is higher than the second flow velocity of the primary flow path.

[0003] In another embodiment, a method involves activating a heater proximate to a bypass channel of an ink delivery pathway. A purge operation is initiated that causes ink to flow through the bypass channel and through a primary channel of the ink delivery pathway. The heater causes ink to flow at a higher velocity through the bypass channel than through the primary channel, and the higher velocity induces bubbles in the ink to flow through the bypass channel instead of the primary channel.

[0004] In another embodiment, an apparatus includes a plurality of stacked layers. Cutouts of the layers form: an inlet port coupled to an ink source; an exit port coupled to an ink delivery element; a vent port; a bypass flow path between the inlet port and the vent port; and a primary flow path between the inlet port and the exit port. A first flow velocity of the bypass flow path is higher than a second flow velocity of the primary flow path. The first flow velocity induces bubbles to travel via the bypass flow path instead of the primary flow path.

[0005] These and other features and aspects of vari-

ous embodiments may be understood in view of the following detailed discussion and accompanying drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

[0006] The discussion below makes reference to the following figures, wherein the same reference number may be used to identify the similar/same component in multiple figures.

FIG. 1 is a schematic diagram of an inkjet manifold flow path according to an example embodiment;

FIG. 2 is a schematic diagram of an inkjet manifold flow path using a heater according to an example embodiment;

FIGS. 3 and 4 are graphs illustrating thermal analyses of example flow path embodiments;

FIG. 5 is a perspective view of an inkjet manifold flow path using multiple channels according to another example embodiment;

FIG. 6 is a perspective view of an inkjet manifold flow path using multiple channels according to another example embodiment;

FIG. 7 is a flowchart showing a procedure according to an example embodiment; and

FIG. 8 is a block diagram of an apparatus according to an example embodiment.

DETAILED DESCRIPTION

[0007] The present disclosure relates to inkjet printing devices. Ink jet printers operate by ejecting small droplets of liquid ink onto print media according to a predetermined pattern. In some implementations, the ink is ejected directly on a final print media, such as paper. In other implementations, the ink is ejected on an intermediate print media, e.g. a print drum, and is then transferred from the intermediate print media to the final print media. Some ink jet printers use cartridges of liquid ink to supply the ink jets. Some printers use phase-change ink which is solid at room temperature and is melted before being jetted onto the print media surface. Phase-change inks that are solid at room temperature allow the ink to be transported and loaded into the ink jet printer in solid form, without the packaging or cartridges typically used for liquid inks.

[0008] In a liquid state, ink may contain bubbles that can obstruct the passages of the ink jet pathways. For example, bubbles can form in solid ink printers due to the freeze-melt cycles of the ink that occur as the ink freezes when printer is powered down and melts when the printer is powered up for use. As the ink freezes to a solid, it contracts, forming voids in the ink that can be subsequently filled by air. When the solid ink melts prior to ink jetting, the air in the voids can become bubbles in the liquid ink.

[0009] Enclosed air (bubbles) in the fluid path of an ink jet print head can lead to temporary fail of jets due to

temporary absence of ink or simply disturb the acoustic performance of the ink jet when trapped near the manifold. The formation of bubbles may be an issue for phase change inks, which may shrink by as much as 15% during freeze. The high forces associated with phase changes and the complex and often rigid channel geometries lead to voids caused by delamination, cracking and air leakage or outgassing of components. After thaw the voids become bubbles and mobilize and follow the ink flow towards the jets.

[0010] To ensure proper system performance, it is desirable to move bubbles away from the jets and eventually vent them out of the system. This is sometimes done with a purge: pushing enough ink volume through the print head until it is bubble free. The ink volume that is needed for a successful purge depends on locations of voids, path lengths and which paths the bubbles chose at intersections. A purge may be done after each on-off cycle when the print head is being warmed up.

[0011] The proposed embodiments use branching channel networks with variable fluidic resistance to guide bubbles along predetermined paths. At branching intersections, bubbles tend to follow the path with the higher flow rate or velocity. The exact bubble behavior depends on geometry but can be pre-determined during channel design. By arranging a network of parallel channels it is possible to guide bubbles to a final path that only accounts for a fraction of the total flow rate. This path can then lead to a vent or back to the ink reservoir.

[0012] Another way to achieve the desired difference in fluidic resistance of parallel channels is by using the temperature dependence of the ink's viscosity. One or more heater elements and separating layers of low thermal conductivity can be arranged in a way to impose a temperature gradient across the parallel channels which leads to a corresponding gradient in fluidic resistance. The heater element can be triggered by a bubble detection technique (capacitive, acoustic, or others) ahead of the branching point to activate the higher venting flow rate only when a bubble is present. Fracture of bubbles at intersections should not occur due to the small geometries and flow rates associated with ink jet flows.

[0013] Embodiments described in this disclosure utilize features to remove bubbles from ink flows before they reach critical components, such as narrow manifold passages, jets, etc. For purposes of the present discussion, the term "manifold" will be used to describe a fluid flow path between a source of ink (e.g., tank, reservoir) and a destination (e.g., jet, orifice). As a result, the embodiments are not intended to be limited to particular manifold embodiments, e.g., fluid paths with multiple input paths and/or multiple output paths. As described hereinbelow, the manifold may have at least one ink supply port coupled to an ink supply and at least one ink delivery port. A port may at least include any passageway, opening, orifice, permeable member, etc., that fluidly couples one ink passageway to another.

[0014] In reference now to FIG. 1, a schematic diagram

illustrates an inkjet manifold flow path **100** according to an example embodiment. The flow path **100** includes an ink supply port **102** and an ink delivery port **104** fluidly coupled via an elongated, primary passageway **106**. The ink supply port **102** is an inlet port coupled to an ink supply (e.g., reservoir) and the ink delivery port **104** is an exit port coupled to an ink delivery element (e.g., ink jet). A junction **108** couples the input port **102** and/or primary passageway **106** to a bypass passageway **110**. The bypass passageway **110** transports bubbles **112** and (usually) ink to a vent port **114**. The vent port **114** is an outlet that facilitates venting bubbles and fluid flowing through the bypass passageway **110**.

[0015] Fluid flows between ink supply port **102** and both ink delivery port **104** and vent port **114** as indicated by arrows **116**, **117**. Also indicated by the relative sizes of arrows **116**, **117**, is that a flow velocity **V1** in the bypass passageway **110** is higher than a flow velocity **V2** in the primary passageway **106**. It has been found that when a fluid flow containing bubbles **112** is split between two paths, the bubbles **112** will migrate to the path having the higher flow velocity, in this case bypass passageway **110**. As a result, the passageways **106**, **110** and/or surrounding structures are configured to ensure that the velocity **V1** of passageway **110** is higher than a velocity **V2** of passageway **106**. It has been observed that this migration of the bubbles **112** to higher velocity channel **110** works reliably in cases where the size of the channel **110** is approximately the same as the size of the bubbles. This makes such a solution applicable to print heads, because in such an application, bubbles coalesce easily and the channels are relatively small. It is possible, however, that these mechanisms may work for smaller bubbles as well.

[0016] In this and other embodiments, the bypass passageway **110** may be selectively activated during a purging operation (or for other purposes), and de-activated at other times. In FIG. 1, for example, this may be accomplished by blocking or un-blocking the vent port **114** and/or junction **108**. This may be accomplished by a mechanical flow blocking member (e.g., valve, gate, actuator) or using other flow blocking techniques (e.g., cooling part of the path so that ink solidifies and blocks the path). It will be understood that the bypass passageway **110** may be enabled at all times in some configuration, including during device operation. For example, if fluid passing through the vent port **114** can be recovered for use after bubbles have settled out, then the bypass may be used during operation. In other configurations, the bypass may be selectively enabled if needed, e.g., if bubbles are detected upstream from inlet port **102**. This selective enabling can also be performed during a purge operation, such that the bypass is only active for part of the purge operation.

[0017] In reference now to FIG. 2, a schematic diagram illustrates an inkjet manifold flow path **200** that uses heat to cause different flow velocities in passageways according to an example embodiment. The flow path **200** in-

cludes an ink supply port **202** and a plurality of ink delivery ports **204** (e.g., exit ports) fluidly coupled via a primary channel **206**. A junction **208** couples the input port **202** and/or primary channel **206** to a bypass channel **210**. Both the primary and bypass channels **206, 210** are coupled to a vent port **214**. The bypass channel **210** diverts bubbles away from the primary flow path to the vent port **214**.

[0018] A heater **216** (e.g., a resistive heater that may be made of Cr-Ni) is thermally coupled proximate to the venting passageway **210**. This induces a thermal gradient along the flow path **200** such that ink in the bypass channel **210** has a higher temperature than ink in the primary channel **206**. The heat reduces the viscosity of the ink such that, if other flow parameters of the channels **210, 206** are similar (e.g., length, cross sectional area, surface roughness), then fluid will flow faster through the path having the higher temperature. This is indicated in FIG. 2 with velocity **V1** of the bypass channel **210** having a higher magnitude than velocity **V2** of the primary channel **210**.

[0019] It will be appreciated that alternate devices or structures may be used to induce a relative temperature differential between channels **206** and **210**. For example, if a heat source uniformly heats structures surrounding the flow path **200**, then cooling source (e.g., heat sink, heat pipes, cooling elements) may be positioned proximate the primary channel **206** so that the ink flowing through the primary channel **206** has a lower temperature than ink flowing through bypass channel **210**.

[0020] The channels **206, 210** in FIG. 2 may be substantially planar, e.g., formed from parallel layers of material with cutouts between facing surfaces forming the channels **206, 210**. In one example structure, the flow path **200** may be formed from a bottom layer **220** of stainless steel through which vias are formed to create the delivery ports **204** and vent port **214**. A stainless steel channel layer **221** has a cutout that forms the supply port **202** and primary channel **206**. A resistance layer **222** may be formed from a polymer (e.g., polyimide) and separates the primary and bypass channels **206, 210**. The resistance layer **222** acts as a thermal insulator that helps to increase the temperature difference between the channels **206, 210**.

[0021] The resistance layer **222** includes a via that forms the junction **208** as well as a via **209** that couples the bypass channel **210** to the vent port **214**. A bypass channel layer **223** may be made from stainless steel, and has a cutout that forms the bypass channel **210**. An optional top layer **224** may be used separate the bypass channel **210** from the heater **216**. The top layer **224** may be relatively thin and/or have a high coefficient of thermal conductance in order to effectively transfer heat from the heater **216** to fluid flowing within bypass channel **210**. Alternatively, the heater **216** may be used to seal the bypass channel **210** directly.

[0022] In FIGS. 3 and 4, graphs illustrate results of a thermal analysis applied to a heating arrangement as

shown in FIG. 2. Curves **302-304** show temperature profiles over distance from the heated surface across an infinite slab of polyimide, here chosen as an approximation for ink/polyimide/ink layers. Each curve **302-304** represents the profile for times of 1, 3, and 5 seconds after the heater is turned on. Starting at $x=0$ (where x is indicated by arrow **219** in FIG. 2), the temperature profiles were split into 300um wide sections **306-308** and averaged to approximate conditions in the layers.

[0023] The average temperatures of sections **306** and **308** respectively represent temperatures of ink in the two channels **206** and **210** of FIG. 2. This temperature difference is plotted as ΔT in FIG. 4, which indicates the temperature difference reaches 5 °C at 2.5 seconds. The temperature difference approaches a steady state value between 6 and 8° C for $t > 10$ sec. To avoid overheating of the wax it, it may be desirable to only use a short pulse of heat just before the purge is going to start, and so for purposes of the following analysis, a 5 °C differential are assumed.

[0024] The viscosity of solid ink in an example ink jet configuration is about 10 mPa*s at the working temperature of 120 °C, and the temperature dependence of viscosity around that operating point is -0.18 mPa*s/°C. Assuming the flow is laminar, the fluidic resistance is directly proportional to viscosity, and so increasing the temperature by 5 °C decreases the resistance by 9%. Consequently, given the temperature profile shown in FIG. 3, the flow velocity through the bypass channel **210** would be about 9% higher than flow through the primary channel **206**, and thereby the bypass channel **210** would be a preferred path for bubbles. As noted above, it would take about three seconds to establish a temperature difference that would allow a 9-10% higher flow in the bypass.

[0025] In some cases (e.g., where cross-sectional areas normal to the flow are similar), the different flow velocities between paths **206, 210** may result in flow volume (e.g., volume of fluid per unit of time passing through the passageway) of the bypass channel **210** being greater than that of the primary channel **206**. In some situations, it may be preferable that bypass flows be smaller than primary flows, e.g., to minimize an amount of ink sent to vent port, which may be discarded in some configurations. In reference now to FIG. 5, a schematic diagram illustrates a flow path **500** according to an example embodiment that results in a bypass flow volume that is lower than a primary flow volume.

[0026] The flow path **500** may be fabricated by stacking up pre-cut layers of material, e.g., sheet stainless steel. The path **500** includes an ink supply port **502** and an ink delivery port **504** fluidly coupled via a plurality of channels **506A-506C** that collectively form a primary passageway **506**. Junctions **508A-508C** couple the channels **508A-508C** to each other and to a bypass channel **510**. The bypass channel **510** diverts bubbles away from the primary flow channel **506** to a vent port **514**.

[0027] Each of the channels **506A-506C** is configured to have an increasingly higher flow velocity **V4-V2** the

further away the channels are from the supply port **502**. The bypass channel **510** has a higher flow velocity **V1** than any of the channels **506A-506C**. In this embodiment, the differing flow velocities are achieved by staggering the junctions, which varies channel lengths between the supply/inlet port **502** and exit ports **504, 514**. All else being equal, a longer channel will have higher resistance to fluid flow, and thereby have lower flow velocity for same/similar pressure differentials between inlet and port **502** and exit ports **504, 514**.

[0028] The fluidic resistance of each channels **506A-506C, 510** may be designed so that at each junction **508A-508D** there is a 1.2 times higher flow rate going to the next layer in relation to the flow that stays in the layer. For example, channels **506A-506C** may pass 45%, 25%, and 14% of the flow, respectively, and the remaining 16% of the total flow goes through the bypass channel **510**. Recombination of the channels **506A-506C** at delivery port **504** amounts to 84% of the total incoming flow. Because of the highest flow velocity **V1** in bypass channel **510**, the bubbles would be induced to travel to the bypass channel **510**. However, because flow is divided amongst multiple channels, the bypass flow accounts for only 16% of the total flow. This reduces the amount of ink that is ejected through the vent **514** during purging operations.

[0029] It will be understood that any geometric or material property that affects flow rate or flow velocity can be used to influence migration of bubbles into a bypass channel instead of a primary channel. One alternate arrangement is shown in FIG. 6, which is a schematic diagram illustrating a flow path **600** according to another example embodiment. The flow path **600** may be fabricated by stacking up pre-cut layers of material, e.g., sheet stainless steel. The flow path **600** includes an ink supply port **602** and an ink delivery port **604** fluidly coupled via a plurality of channels **606A-606C** that collectively form a primary passageway **606**. Junction **508** couple the channels **508A-508C** to each other and to a bypass channel **610**. The bypass channel **610** diverts bubbles away from the primary flow channel **606** to a vent port **614**.

[0030] Each of the channels **606A-606C** is configured to have an increasingly higher flow velocity **V4-V2** the further away the channels are from the supply port **602**. The bypass channel **610** has a higher flow velocity **V1** than any of the channels **606A-606C**. In this embodiment, the differing flow velocities are achieved by increasing the height of the channels **606A-606C, 610**, all of which have an approximately equal length between inlet port **602** and exit ports **604, 614**. All else being equal, a narrower channel will have higher resistance to fluid flow, and thereby have lower flow velocity for same/similar pressure differentials between inlet and port **502** and exit ports **504, 514**. As with the embodiment shown in FIG. 5, the relative amount of flow through the bypass **614** can be significantly less than the primary channel **606**, even though flow velocity/rate is higher through the bypass **614** than through individual channels **606A-606C**.

[0031] It will be appreciated that the embodiments shown in FIGS. 5 and 6 may be combined with a heater as shown in FIG. 2. Using FIG. 5 as an example, a heating element may be placed proximate the bypass channel **510**, which will reduce viscosity of ink in the channel **510** causing a further flow velocity increase in the channel. The combination of a heater and varying channel velocity may be used to strike a balance between channel complexity (e.g., reduce the number of primary passageway channels) and relative amount of ink sent through bypass to remove bubbles.

[0032] In reference now to FIG. 7, a flowchart illustrates a procedure according to an example embodiment. The procedure involves activating **702** a heater proximate to a bypass channel of an ink delivery path way. A purge operation is initiated **704**, the operation causing ink to flow through the bypass channel and through a primary channel of the ink delivery pathway. In response to the heater being activated, ink is caused **706** to flow at a higher velocity through the bypass channel than through the primary channel. The higher velocity induces bubbles in the ink to flow through the bypass channel instead of the primary channel.

[0033] In FIG. 8, a block diagram illustrates an apparatus **800** according to an example embodiment. The apparatus **800** includes a print head **802** with a flow path/manifold **804** having bypass and primary flow paths as described herein. The flow path **804** delivers ink from a reservoir **806** to ink jets **808** for application to a printing media **810** (or intermediary printing surface). The apparatus **800** includes a controller **812** that is capable of controlling various functions of the apparatus **800**, e.g., via dedicated logic circuitry via execution of instructions via a special-purpose or general-purpose processing unit.

[0034] The controller **812** may be coupled to a heater **814** of the print head **802**. The heater **814** may facilitate melting solid ink to facilitate flow through the flow path **804**, and may be configured to induce a temperature differential such as shown in the example embodiment of FIG. 2. The controller **812** may also be coupled to a mechanical and/or thermal element **816** that facilitates selectively enabling a bypass of the flow path **804** to enable removal of bubbles via the bypass to a vent (not shown). The controller **812** may be coupled to a sensor **818** that detects bubbles, and in response thereto, selectively activate element **816** to block or un-block the bypass as appropriate.

[0035] The foregoing description of the example embodiments has been presented for the purposes of illustration and description. It is not intended to be exhaustive or to limit the embodiments to the precise form disclosed. Many modifications and variations are possible in light of the above teaching. For example, although embodiments are shown herein as parallel paths formed by cut outs in stacked plates, the embodiments may also be applicable to non-parallel channels, and to alternate formation of flow paths. For example, flow path structures may be formed using injection molding, casting, etching,

micromachining, layer deposition, and other fabrication methods known in the art.

[0036] Any or all features of the disclosed embodiments can be applied individually or in any combination are not meant to be limiting, but purely illustrative. All features disclosed in association with a particular embodiment are intended to be interchangeable individually with other embodiments. It is intended that the scope of the invention be limited not with this detailed description, but rather determined by the claims appended hereto.

Claims

1. An apparatus, comprising:

a bypass flow path between an ink supply port and a vent port;

a primary flow path between the ink supply port and an ink delivery port; and

a heater configured to induce a first temperature in the bypass flow path that is higher than a second temperature of the primary flow path, wherein the first temperature reduces a viscosity of ink flowing in the first path such that a first flow velocity of the bypass flow path is higher than a second flow velocity of the primary flow path, and wherein the first flow velocity induces bubbles to travel via the bypass flow path instead of the primary flow path.

2. The apparatus of claim 1, further comprising a thermal insulator between the bypass and primary flow paths.

3. The apparatus of any of claims 1 through 2, wherein the ink delivery port comprises a plurality of exit ports, and wherein the primary flow path is coupled to the vent port downstream from the plurality of exit ports.

4. The apparatus of any of claims 1 through 3, wherein the primary flow path comprises two or more parallel channels coupled to each other by junctions, wherein one of the channels is parallel to and coupled to the bypass flow path by one of the junctions, wherein each of the two or more channels has a greater flow resistance than the bypass flow path.

5. The apparatus of claim 4, wherein the junctions are staggered relative to each other in a downstream direction so that lengths of the channels increase in relation to distances of the channels from bypass flow path, and wherein flow resistances of the channels are proportional to the lengths of the channels.

6. The apparatus of any of claims 1 through 5, wherein the apparatus comprises a plurality of stacked layers, and wherein the bypass and primary flow paths

are formed as cutouts within the stacked layers.

7. The apparatus of any of claims 1 through 6, further comprising a mechanical flow blocking member that facilitates selectably blocking the bypass flow path.

8. The apparatus of claim 7, further comprising a sensor configured to detect the bubbles, and a controller coupled to the sensor and the mechanical flow blocking member, the controller configured to selectably block the bypass flow path in response to detecting the bubbles.

9. A method comprising:

activating a heater proximate to a bypass channel of an ink delivery path way; and
initiating a purge operation that causes ink to flow through the bypass channel and through a primary channel of the ink delivery pathway, wherein the heater causes ink to flow at a higher velocity through the bypass channel than through the primary channel, and wherein the higher velocity induces bubbles in the ink to flow through the bypass channel instead of the primary channel in response to the purge operation.

10. The method of claim 9, wherein initiating the purge operation further comprises selectably enabling flow through the bypass channel for the purge operation, and selectably disabling flow through the bypass channel otherwise.

11. The method of claim 9 or claim 10, further comprising detecting the bubbles, and wherein the flow through the bypass channel is selectably enabled in response to detecting the bubbles.

12. The method according to any of claims 9 to 11, wherein a collective flow rate through the channels is greater than a flow rate through the bypass flow path.

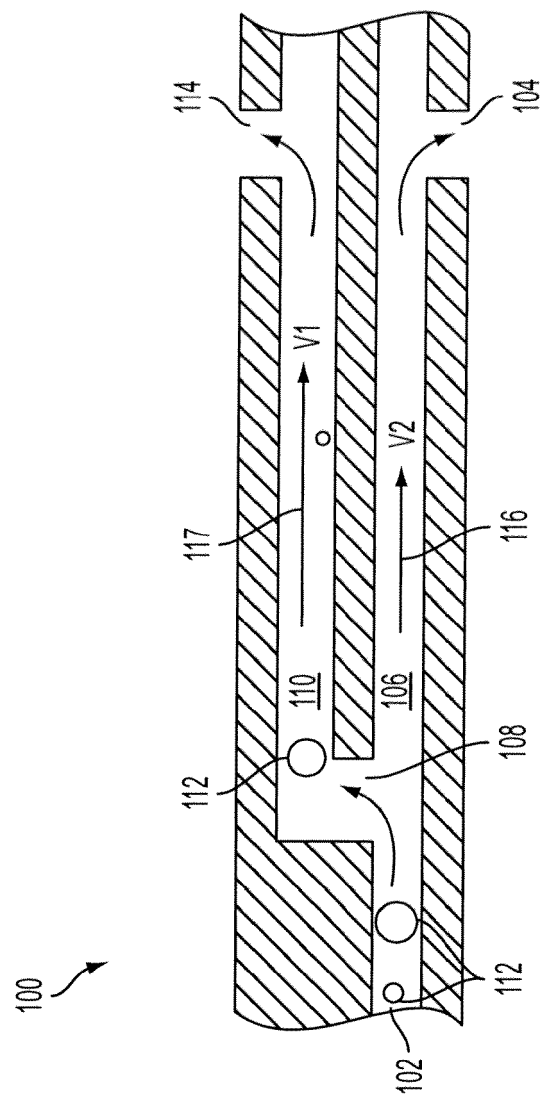


FIG. 1

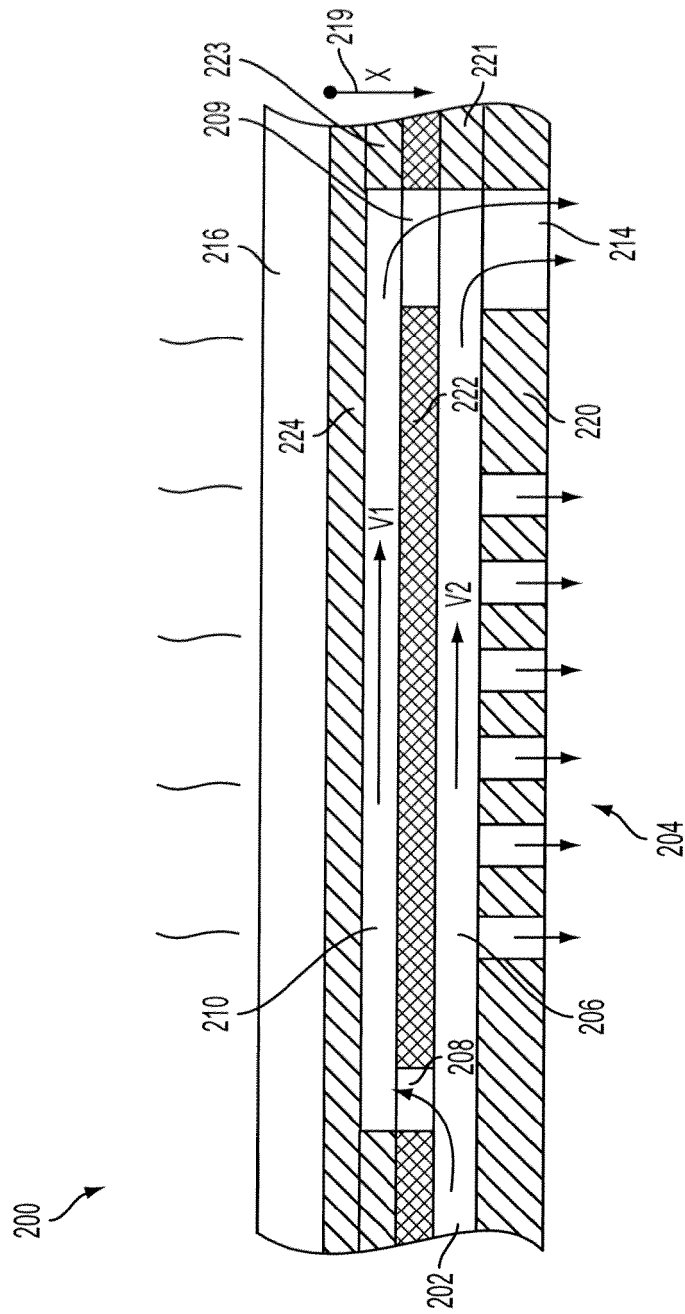


FIG. 2

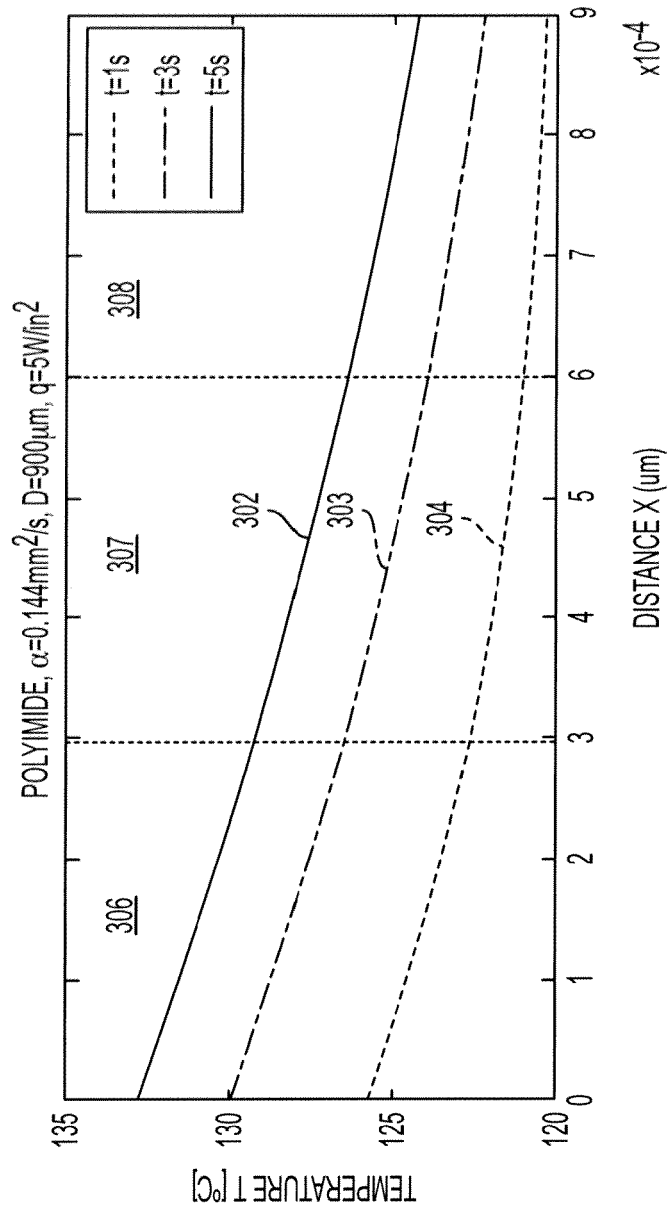


FIG. 3

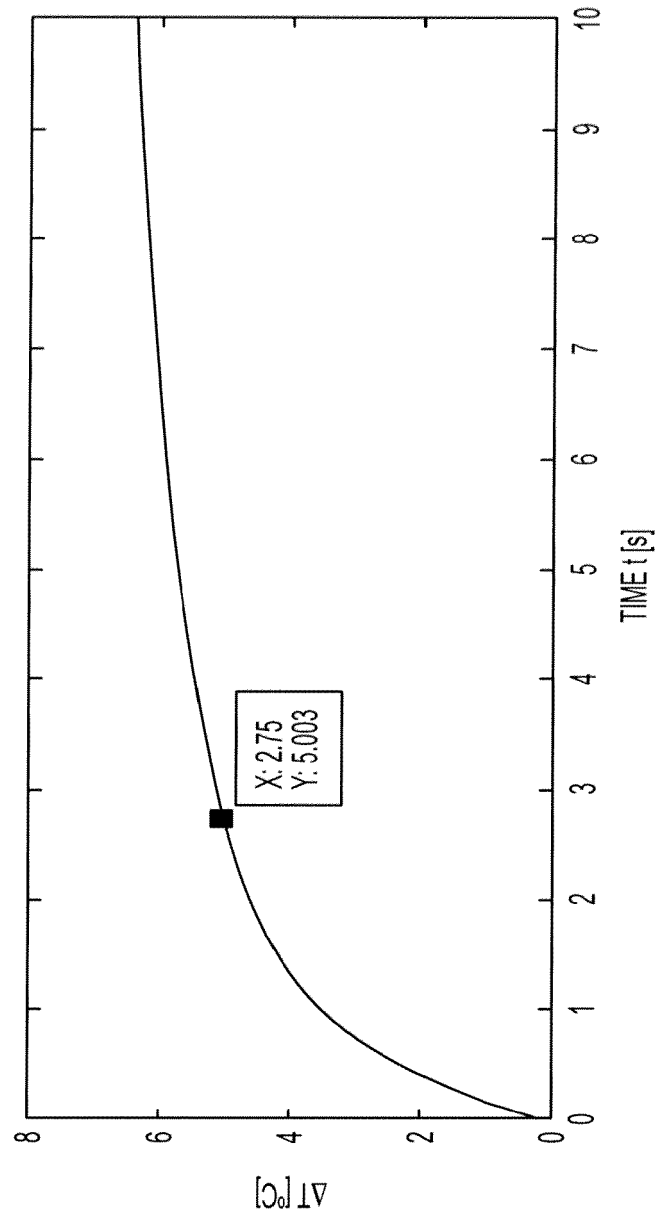


FIG. 4

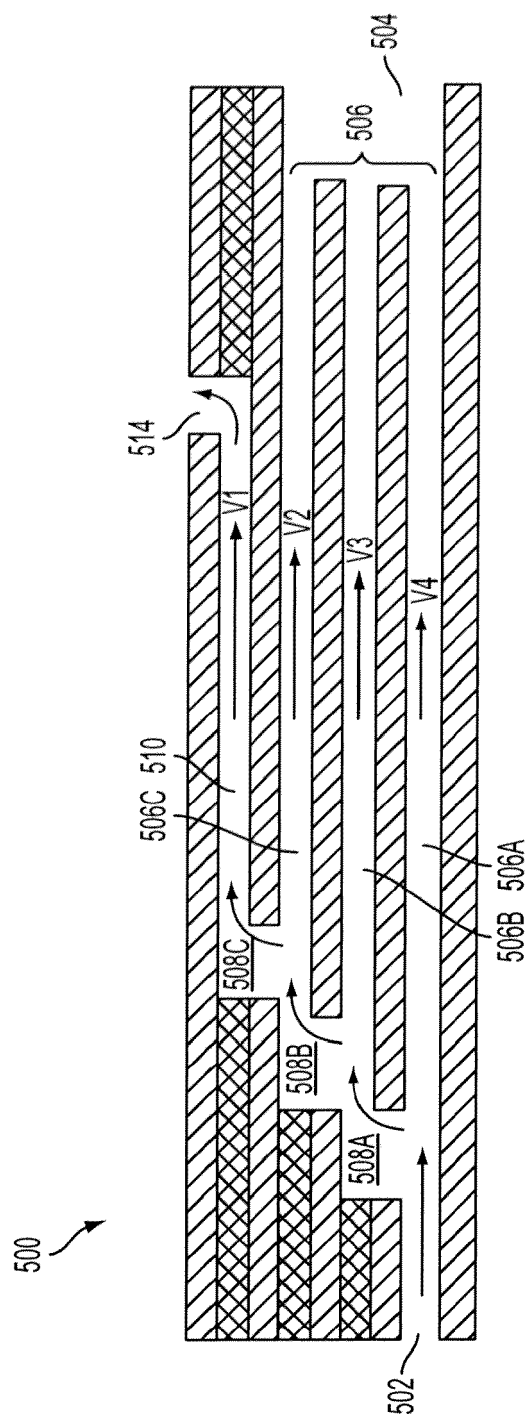


FIG. 5

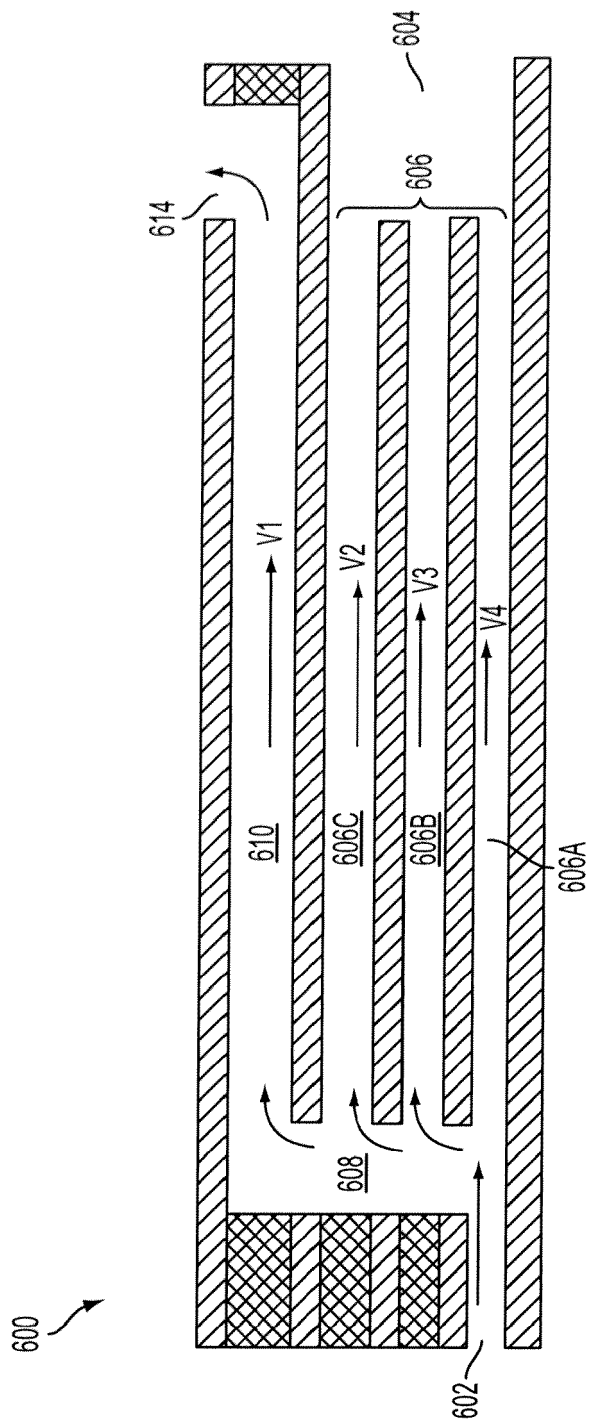


FIG. 6

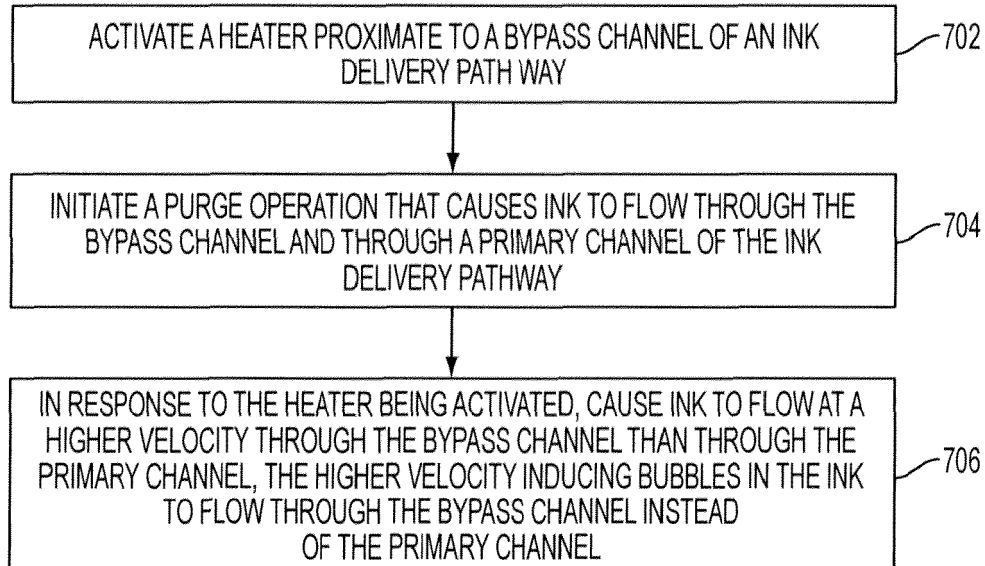


FIG. 7

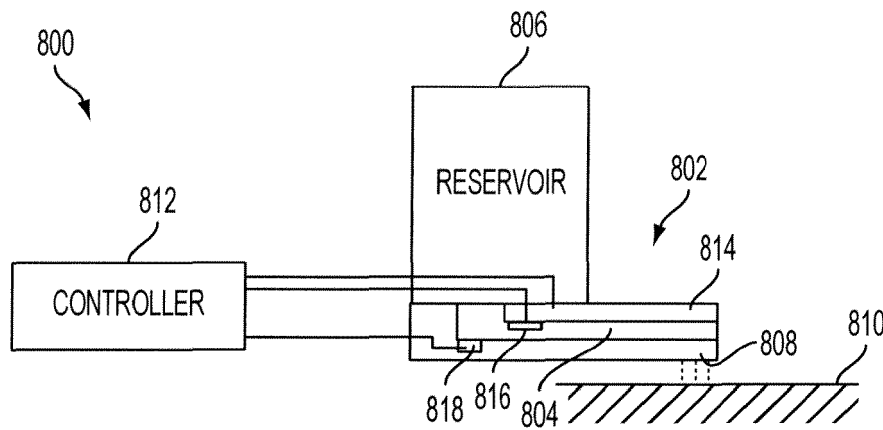


FIG. 8



EUROPEAN SEARCH REPORT

Application Number
EP 13 19 5104

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (IPC)
A	JP H06 143565 A (SHARP KK) 24 May 1994 (1994-05-24) * abstract *	1,9	INV. B41J2/19
A	JP H01 145156 A (NIPPON DENKI HOME ELECTRONICS) 7 June 1989 (1989-06-07) * abstract; figures *	1,9	
A	EP 2 305 472 A1 (FUJIFILM CORP [JP]; FUJI XEROX CO LTD [JP]) 6 April 2011 (2011-04-06) * abstract * * paragraph [0062] - paragraph [0065] * * paragraph [0093] - paragraph [0098] * * figures 4,6 *	1,9	
A	JP S61 16865 A (EPSON CORP; SUWA SEIKOSHA KK) 24 January 1986 (1986-01-24) * abstract; figures *	1,9	
A	WO 2011/080115 A2 (WRIGHTSOLAR LTD [GB]; WRIGHT ALAN DEREK [GB]) 7 July 2011 (2011-07-07) * the whole document *	1,9	
The present search report has been drawn up for all claims			TECHNICAL FIELDS SEARCHED (IPC)
			B41J
Place of search		Date of completion of the search	Examiner
The Hague		11 February 2014	Didenot, Benjamin
CATEGORY OF CITED DOCUMENTS X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document			

 1
EPO FORM 1503 03 82 (P04C01)

**ANNEX TO THE EUROPEAN SEARCH REPORT
ON EUROPEAN PATENT APPLICATION NO.**

EP 13 19 5104

This annex lists the patent family members relating to the patent documents cited in the above-mentioned European search report. The members are as contained in the European Patent Office EDP file on
The European Patent Office is in no way liable for these particulars which are merely given for the purpose of information.

11-02-2014

Patent document cited in search report		Publication date	Patent family member(s)	Publication date
JP H06143565	A	24-05-1994	NONE	
JP H01145156	A	07-06-1989	NONE	
EP 2305472	A1	06-04-2011	EP 2305472 A1	06-04-2011
			JP 2011079169 A	21-04-2011
			US 2011080456 A1	07-04-2011
JP S6116865	A	24-01-1986	JP S6116865 A	24-01-1986
			JP S6159915 B2	18-12-1986
WO 2011080115	A2	07-07-2011	AU 2010338399 A1	02-08-2012
			EP 2512811 A2	24-10-2012
			GB 2477599 A	10-08-2011
			US 2013014843 A1	17-01-2013
			WO 2011080115 A2	07-07-2011

EPO FORM P0459

For more details about this annex : see Official Journal of the European Patent Office, No. 12/82